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NC7SV57 / NC7SV58 TinyLogic[®] ULP-A Universal Configurable Two-Input Logic Gates

Features

FAIRCHILD SEMICONDUCTOR

- 0.9V to 3.6V V_{CC} Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at V_{CC} from 0.9V to 3.6V
- Extremely High Speed tPD
 - 2.5ns: Typical for 2.7V to 3.6V V_{CC}
 - 3.1ns: Typical for 2.3V to 2.7V V_{CC}
 - 4.0ns: Typical for 1.65V to 1.95V V_{CC}
 - 6.0ns: Typical for 1.4V to 1.6V V_{CC}
 - 8.0ns: Typical for 1.1V to 1.3V V_{CC}
 - 23.0ns: Typical for 0.9V V_{CC}
- Power-Off High-Impedance Inputs and Outputs
 - High Static Drive (I_{OH}/I_{OL})
 - ±24mA at 3.00V V_{CC}
 - $\pm 18 mA$ at 2.30V V_{CC}
 - ±6mA at 1.65V V_{CC}
 - $\pm 4mA$ at 1.4V V_{CC}
 - $\pm 2mA$ at 1.1V V_{CC}
 - $\pm 0.1 mA$ at 0.9V V_{CC}
- Proprietary Quiet Series[™] Noise/EMI Reduction
- Ultra-Small MicroPak[™] Package
- Ultra-Low Dynamic Power

Description

The NC7SV57 and NC7SV58 are universal configurable two-input logic gates from Fairchild's Ultra-Low Power (ULP-A) series of TinyLogic[®]. ULP-A is ideal for applications that require extreme high-speed, high drive, and low power. This product is designed for a wide low-voltage operating range (0.9V to 3.6V V_{CC}) and applications that require more drive and speed than the TinyLogic[®] ULP series, but still offer best-in-class, low-power operation.

Each device is capable of being configured for 1 of 5 unique two-input logic functions. Any possible two-input combinatorial logic function can be implemented, as shown in the *Function Selection Table*. Device functionality is selected by how the device is wired at the board level. *Figures 1 through 10* illustrate how to connect the NC7SV57 and NC7SV58, respectively, for the desired logic function. All inputs have been implemented with hysteresis.

The NC7SV57 and NC7SV58 are uniquely designed for optimized power and speed and are fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

Top Mark	Package	Packing Method						
V57	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel						
H3	6-Lead Micropak™, 1.0mm Wide	5000 Units on						
H3	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	Tape & Reel						
V58	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel						
NC7SV58L6X H4 6-Lead Micropak™, 1.0mm Wide		5000 Units on						
H4	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	Tape & Reel						
	Top Mark V57 H3 H3 V58 H4	Top MarkPackageV576-Lead SC70, EIAJ SC-88a, 1.25mm WideH36-Lead Micropak™, 1.0mm WideH36-Lead, MicroPak2™, 1x1mm Body, .35mm PitchV586-Lead SC70, EIAJ SC-88a, 1.25mm WideH46-Lead Micropak™, 1.0mm Wide						

Ordering Information





Pin Definitions

Pin # SC70	Pin # MicroPak™	Name	Description
1	1	l ₁	Data Input
2	2	GND	Ground
3	3	I ₀	Data Input
4	4	Y	Output
5	5	V _{CC}	Supply Voltage
6	6	l ₂	Data Input

Function Table

	Inputs		NC7SV57	NC7SV58
l ₂	I ₁	I ₀	$Y = \overline{(I_0)} \bullet \overline{(I_2)} + (I_1) \bullet (I_2)$	$Y = (I_0) \bullet \overline{(I_2)} + \overline{(I_1)} \bullet (I_2)$
L	L	L	Н	L
L	L	Н	L	Н
L	Н	L	Н	L
L	Н	Н	L	Н
Н	L	L	L	Н
Н	L	Н	L	Н
Н	Н	L	Н	L
Н	Н	Н	Н	L

H = HIGH Logic Level

L = LOW Logic Level

Function Selection Table

2-Input Logic Function	Device Selection	Connection Configuration
2-Input AND	NC7SV57	Figure 5
2-Input AND with Inverted Input	NC7SV58	Figure 11, Figure 12
2-Input AND with Both Inputs Inverted	NC7SV57	Figure 8
2-Input NAND	NC7SV58	Figure 10
2-Input NAND with Inverted Input	NC7SV57	Figure 6, Figure 7
2-Input NAND with Both Inputs Inverted	NC7SV58	Figure 13
2-Input OR	NC7SV58	Figure 13
2-Input OR with Inverted Input	NC7SV57	Figure 6, Figure 7
2-Input OR with Both Inputs Inverted	NC7SV58	Figure 10
2-Input NOR	NC7SV57	Figure 8
2-Input NOR with Inverted Input	NC7SV58	Figure 10, Figure 11
2-Input NOR with Both Inputs Inverted	NC7SV57	Figure 5
2-Input XOR	NC7SV58	Figure 14
2-Input XNOR	NC7SV57	Figure 9







NC7SV58 Logic Configurations

Figure 10 through Figure 14 show the logical functions that can be implemented using the NC7SV58. The diagrams show the DeMorgan's equivalent logic duals for a given two-input function. The logical

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	meter	Min.	Max.	Unit
V _{CC}	Supply Voltage		-0.5	4.6	V
V _{IN}	DC Input Voltage		-0.5	4.6	V
M		HIGH or LOW State ⁽⁶⁾	-0.5	V _{CC} + 0.5	
Vout	DC Output Voltage	V _{CC} =0V	-0.5	4.6	V
I _{IK}	DC Input Diode Current	V _{IN} < 0V		±50	mA
		V _{OUT} < 0V		-50	
loκ	DC Output Diode Current	$V_{OUT} > V_{CC}$		+50	mA
I _{OH} / I _{OL}	DC Output Source / Sink Curren	nt		±50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current per	Supply Pin		±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
		MicroPak™-6		130	
PD	Power Dissipation at +85°C	SC70-6		150	mW
		MicroPak2™-6		120	
FOD	Human Body Model, JEDEC:JE		4000	N/	
ESD	Charged Device Model, JEDEC	:JESD22-C101		2000	V

Note:

6. IO absolute maximum rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
Vcc	Supply Voltage Operating		0.9	3.6	V	
V _{IN}	Input Voltage		0	3.6	V	
V		V _{CC} =0V	0	3.6	V	
V _{OUT}	Output Voltage	HIGH or LOW State	0	Vcc	v	
		V _{CC} =3.0V to 3.6V		±24.0		
	Output Current	V _{CC} =2.3V to 2.7V		±18.0	mA	
		V _{CC} =1.65V to 1.95V		±6.0		
I _{OH} /I _{OL}		V _{CC} =1.4V to 1.6V		±4.0		
		V _{CC} =1.1V to 1.3V		±2.0		
		V _{CC} =0.9V		±0.1	μA	
TA	Operating Temperature, Free Air		-40	+85	°C	
$\Delta t / \Delta V$	Minimum Input Edge Rate	V _{IN} =0.8V to 2.0, V _{CC} =3.0V		10	ns/\	
		SC70-6		425		
θ_{JA}	Thermal Resistance	MicroPak™-6		500	°C/M	
		MicroPak2™-6		560		

Note:

7. Unused inputs must be held HIGH or LOW. They may not float.

.		V		T _A =25	5°C	T _A =-40 t	to 85°C	
Symbol Parameter	V _{cc}	Conditions	Min.	Max.	Min.	Max.	Units	
		0.90		0.30	0.70	0.30	0.70	
		1.10		0.40	1.00	0.40	1.00	
VP	Positive Threshold	1.40		0.50	1.40	0.50	1.40	v
۷P	Voltage	1.65		0.70	1.50	0.70	1.50	v
		2.30		1.00	1.80	1.00	1.80	
		2.70		1.30	2.20	1.30	2.20	
		0.90		0.10	0.60	0.10	0.60	
		1.10		0.15	0.70	0.15	0.70	
V _N	Negative Threshold	1.40		0.20	0.80	0.20	0.80	v
۷N	Voltage	1.65		0.25	0.90	0.25	0.90	v
		2.30		0.40	1.15	0.40	1.15	
		2.70		0.60	1.50	0.60	1.50	
	0.90		0.07	0.50	0.07	0.50		
		1.10		0.08	0.60	0.08	0.60	
Vн	Hysteresis Voltage	1.40		0.10	0.80	0.10	0.80	V
∨н	Trysteresis voltage	1.65		0.15	1.00	0.15	1.00	
		2.30		0.25	1.10	0.25	1.10	
		2.70		0.40	1.20	0.40	1.20	
		0.90		V _{CC} -0.1		V _{cc} -0.1		
		$1.10 \leq V_{CC} \leq 1.30$		V _{CC} -0.1		V _{CC} -0.1		
		$1.40 \leq V_{CC} \leq 1.60$	1 - 100.04	V _{CC} -0.2		V _{CC} -0.2		
		$1.65 \leq V_{C\!,\!C\!} \leq 1.95$	I _{ОН} =-100µА	V _{CC} -0.2		V _{CC} -0.2		
		$2.30 \leq V_{CC} \leq 2.70$		V _{CC} -0.2		V _{CC} -0.2		
		$2.70 \leq V_{CC} \leq \ 3.60$		V _{CC} -0.2		V _{CC} -0.2		
		$1.10 \leq V_{CC} \leq 1.30$	I _{OH} =-2mA	.75 x V _{CC}		.75 x V _{CC}		
V _{OH}	HIGH Level Output Voltage	$1.40 \leq V_{CC} \leq 1.60$	I _{OH} =-4mA	.75 x V _{CC}		.75 x V _{CC}		V
	voltage	$1.65 \leq V_{CC} \leq 1.95$		1.25		1.25		
		$2.30 \leq V_{CC} \leq 2.70$	I _{OH} =-6mA	2.0		2.0		
		$2.30 \leq V_{CC} \leq 2.70$		1.8		1.8		
		$2.70 \le V_{CC} \le 3.60$	I _{OH} =-12mA	2.2		2.2		-
		$2.30 \le V_{CC} \le 2.70$		1.7		1.7	1	
		$2.70 \le V_{CC} \le 3.60$	— Iou=-18mA	2.4		2.4		1
		$2.70 \le V_{CC} \le 3.60$	I _{OH} =-24mA	2.2		2.2		-

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Continued on following page....

Sumbel	Deremete-		Conditions	T _A =	25°C	T _A =-40) to 85°C	Units
Symbol	Symbol Parameter	V _{cc}	Conditions	Min.	Max.	Min.	Max.	Units
		0.90			0.1		0.1	
		$1.10 \leq V_{CC} \leq 1.30$			0.1		0.1	
		$1.40 \leq V_{CC} \leq 1.60$	1 -100.04		0.2		0.2	
		$1.65 \leq V_{CC} \leq 1.95$	Ι _{ΟL} =100μΑ		0.2		0.2	
		$2.30 \leq V_{CC} \leq 2.70$			0.2		0.2	
		$2.70 \leq V_{CC} \leq 3.60$			0.2		0.2	1
	LOW Level Output	$1.10 \leq V_{CC} \leq 1.30$	I _{OL} =2mA		.25 x V _{CC}		.25 x V _{CC}	
VOL	V _{OL} Voltage	$1.40 \leq V_{CC} \leq 1.60$	I _{OL} =4mA		.25 x V _{CC}		.25 x V _{CC}	V
		$1.65 \leq V_{CC} \leq 1.95$	I _{OL} =6mA		0.3		0.3	
		$2.30 \leq V_{CC} \leq 2.70$	L =10m A		0.4		0.4	
		$2.70 \leq V_{CC} \leq 3.60$	I _{OL} =12mA		0.4		0.4	
		$2.30 \leq V_{CC} \leq 2.70$	40		0.6		0.6	
		$2.70 \leq V_{CC} \leq 3.60$	I _{OL} =18mA		0.4		0.4	
		$2.70 \leq V_{CC} \leq 3.60$	I _{OL} =24mA		0.55		0.55	
I _{IN}	Input Leakage Current	0.90 to 3.60	$0 \leq V_{IN} \leq 3.6V$		±0.1		±0.5	μA
I _{OFF}	Power Off Leakage Current	0	$0 \leq (V_{IN,}V_O) \leq 3.60$		0.5		0.5	μA
	Quiescent Supply	0.00 to 2.00	$V_{IN}=V_{CC}$ or GND		0.9		0.9	
ICC	I _{CC} Current	0.90 to 3.60	$V_{CC} \leq V_{IN} \leq 3.6V$				±0.9	μA

AC Electrical Characteristics

Cumphiel	Devementer	N/	Conditions		T _A =25°(2	T _A =-40	to 85°C	L lucito	Figure	
Symbol	Parameter	V _{cc}	Conditions	Min.	Тур.	Min.	Тур.	Min.	Units	Figure	
		0.90	C_L =15pF, R _L =1M Ω		15.0						
		$1.10 \le V_{CC} \le 1.30$		4.0	8.0	16.5	3.3	31.0			
t _{PHL} , t _{PLH}	Propagation	$1.40 \leq V_{CC} \leq 1.60$	C_L =15pF, R_L =2K Ω	2.0	6.0	10.0	2.0	12.0	ns	Figure 15	
	Delay	$1.65 \leq V_{CC} \leq 1.95$	C _L =30pF, R _L =500Ω		2.0	4.0	9.1	1.9	10.0		Figure 16
		$2.30 \leq V_{CC} \leq 2.70$				1.5	3.1	6.2	1.4	6.7	
		$2.70 \leq V_{CC} \leq 3.60$		1.2	2.5	5.4	1.2	6.1			
C _{IN}	Input Capacitance	0			8				pF		
Cout	Output Capacitance	0			12				pF	K)	
C _{PD}	Power Dissipation Capacitance	0.90 to 3.60	V _I =0V or V _{CC} , f=10MHz		10				pF		





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Package Designator	gnator Tape Section Cavity Number		Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P6X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Package Designator Tape Section		Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



Figure 19. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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Product Status	Definition
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